

Docket No.: P-0242

DECLARATION AND POWER OF ATTORNEY

SEP 20 200 TC 2800 TO 2800 TO 2000 TO TO TO TO THE ROOM

As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled <u>PREDISTORTION</u> DIGITAL LINEARIZER AND GAIN CONTROLLING METHOD THEREOF, the specification of which

an] was filed on mended on	as Application Serial No (if applicable)	and was	Tec
I hereby state that I have by any amendment referre	reviewed and understand the conte- ed to above.	ents of the above identified specific	ation, including the cl	laims, as amer
I acknowledge the duty to Code of Federal Regulation	o disclose information which is knoons, Section 1.56(a).	own to me to be material to patental	bility in accordance w	2
certificate, or 365(a) of ar America, listed below and	ority benefits under 35 U.S.C. 119(a ny PCT international application wh I have also identified below, by chec nal application having a filing date b	hich designated at least one country cking the box, any foreign application	other than the Unite on for patent or inven	ed State £ of itor's certificat
Prior Foreign Application Number	on(s): <u>Country</u>	Foreign <u>Month</u> /	Filing Date Day/Year	Tec
45258/2000	Republic of Korea	8/4/20	000	THE STATE OF THE S
25475/2001	Republic of Korea	5/10/2	001	FEB 0 1 2002 Technology Center 2600
I hereby claim the benefit	under 35 U.S.C. 119(e) of any Unit	ted States provisional application(s)	listed below.	2002 enter 2
Application Number(s)	Filing	Filing Date(Month/Day/Year)		2600
Designating the United St not disclosed in the prior 112, I acknowledge the du	under 35 U.S.C. 120 of any United tates of America, listed below and, United States or PCT international try to disclose information which is ag date of the prior application and	insofar as the subject matter of eac application in the manner provides material to patentability as defined	ch of the claims of the d by the first paragrap I in 37 CFR 1.56 which	is application oh of 35 U.S.C ch became
Prior U. S. Application or PCT Patent Number	Filing Date(Mon	ath/Day/Year) Pares	nt Patent Number(i	f application

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, and Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuart I. Smith, Registration No. 42,159, all of

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with full power of substitution and revocation, to prosecute this application and to Office connected therewith, and all further correspondence should be addressed to	o transact all business in the Patent and Trademark o them
********************************	**************
Full name of solo or first inventor: Jae-Hyuk LEE	
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